

534998-8 ✓ ACTIVE

AMPMODU | Modu Connector System

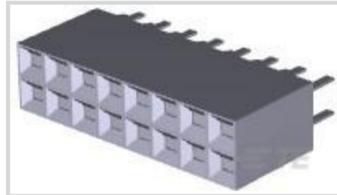
TE Internal #: 534998-8

PCB Mount Receptacle, Vertical, Board-to-Board, 16 Position, 2.54 mm [.1 in] Centerline, Gold (Au), Through Hole - Solder, Modu Connector System

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Type: **PCB Mount Receptacle**

Connector System: **Board-to-Board**

Number of Positions: **16**

Number of Rows: **2**

Centerline (Pitch): **2.54 mm [.1 in]**

## Features

### Product Type Features

Applied Pressure	Standard
PCB Connector Type	PCB Mount Receptacle
Connector System	Board-to-Board
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Connector Product Type	Connector Assembly

### Configuration Features

Stackable	Yes
Number of Positions	16
Number of Rows	2
PCB Mount Orientation	Vertical
Board-to-Board Configuration	Parallel

### Electrical Characteristics

Operating Voltage	333 VAC
Insulation Resistance	5000 MΩ
Dielectric Withstanding Voltage (Max)	750 VAC

### Body Features

Connector Profile	Low
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Primary Product Color Black

### Contact Features

Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	3.81 – 7.62 $\mu$ m
Contact Shape & Form	Round
Contact Protection Type	Closed Entry Housing
Contact Mating Area Length	3.77 mm[.148 in]
Contact Base Material	Phosphor Bronze
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Mating Area Plating Material Thickness	.762 $\mu$ m[30 $\mu$ in]
Contact Mating Area Plating Material	Gold (Au)
Contact Type	Socket
Contact Current Rating (Max)	2 A

### Termination Features

Rectangular Termination Post & Tail Width	.7 mm[.028 in]
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Termination Post & Tail Length	3.18 mm[.125 in]
Termination Method to PCB	Through Hole - Solder

### Mechanical Attachment

Connector Mounting Type	Board Mount
Mating Alignment	Without
PCB Mount Alignment	Without
PCB Mount Retention	Without

### Housing Features

Mating Entry Location	Top
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Thermoplastic

### Dimensions

Connector Height	5.03 mm[.198 in]
Row-to-Row Spacing	2.54 mm[.1 in]
Stack Height	9.02 mm[.355 in]
PCB Thickness (Recommended)	1.57 mm[.055 – .094 in]



### Usage Conditions

Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]

### Operation/Application

Solder Process Feature	Board Standoff
Circuit Application	Signal

### Industry Standards

Compatible With Approved Standards Products	CSA LR7189, UL E28476
UL Flammability Rating	UL 94V-0

### Packaging Features

Packaging Quantity	28
Packaging Method	Box, Tube

### Product Compliance

[For compliance documentation, visit the product page on TE.com>](#)

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	有害物质含量超出标准 Restricted Substance(s) Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2025 (250) Candidate List Declared Against: JUNE 2025 (250) SVHC > Threshold: Pb (13% in 4690948374) <b>Article Safe Usage Statements:</b> Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Not Low Halogen - contains Br or Cl > 900 ppm.
Solder Process Capability	Wave solder capable to 240°C

#### Product Compliance Disclaimer

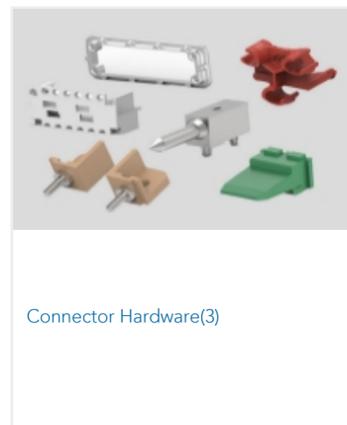
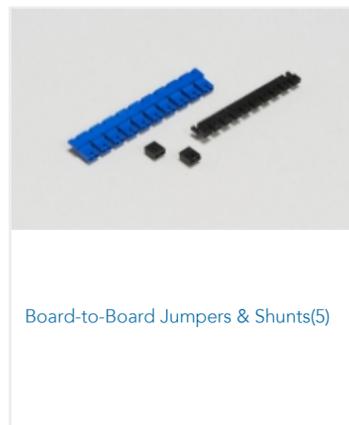
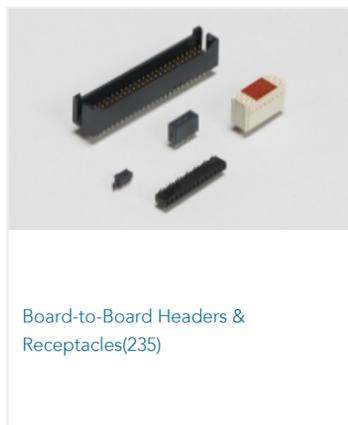
This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits

as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: <https://echa.europa.eu/guidance-documents/guidance-on-reach>

## Compatible Parts

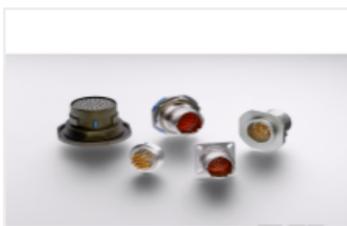


## Also in the Series | Modu Connector System



## Customers Also Bought





TE Part #YDBC34H-10-5PNV001  
HERM RECP



TE Part #TSE-20-01  
JUNCTION ASSY

## Documents

### Product Drawings

[16 MODIV VRT DR CE 100/125](#)

English

### CAD Files

Customer View Model

[ENG\\_CVM\\_CVM\\_534998-8\\_R.2d\\_dxf.zip](#)

English

[3D PDF](#)

3D

Customer View Model

[ENG\\_CVM\\_CVM\\_534998-8\\_R.3d\\_igs.zip](#)

English

Customer View Model

[ENG\\_CVM\\_CVM\\_534998-8\\_R.3d\\_stp.zip](#)

English

By downloading the CAD file I accept and agree to the [Terms and Conditions](#) of use.

### Product Specifications

[Application Specification](#)

English